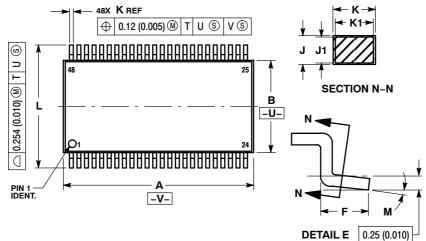


TSSOP-48 CASE 1201-01 **ISSUE B**

DATE 06 JUL 2010

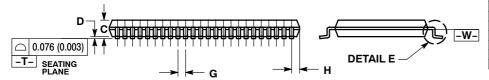




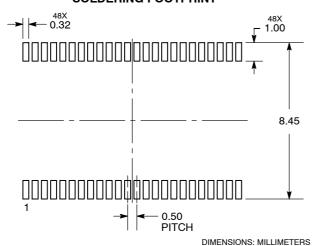
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- DIMENSIONING AND TOLEHANCING PEH ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS.
- SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

 4. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	12.40	12.60	0.488	0.496
В	6.00	6.20	0.236	0.244
С		1.10		0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.50 BSC		0.0197 BSC	
Н	0.37		0.015	
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.17	0.27	0.007	0.011
K1	0.17	0.23	0.007	0.009
Ĺ	7.95	8.25	0.313	0.325
М	0 °	8 °	0 °	8 °



RECOMMENDED SOLDERING FOOTPRINT



GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

= Assembly Location = Wafer Lot WL

YY = Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part

marking.

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DESCRIPTION:	TSSOP-48	PAGE 1 OF 2	



DOCUMENT	NUMBER:
98ASH70297	Α

1201

PAGE 2 OF 2

ISSUE	REVISION	DATE
Α	CHANGED LEGAL OWNERSHIP TO ON. REQ. BY M. ELLINGTON.	20 JAN 2004
В	ADDED SOLDERING FOOTPRINT. REQ. BY J. SONG.	06 JUL 2010

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